PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Hwa-Sung WOO	04/29/2009
Joo-Nyung JANG	04/29/2009
Cheol SHIN	04/29/2009
Yoon-Sung UM	04/29/2009
Mi-Jeong SONG	04/29/2009

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.
Street Address:	416, Maetan-dong, Yeongtong-gu, Gyeonggi-do
City:	Suwon-si
State/Country:	REPUBLIC OF KOREA

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12469429

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 21C-0613P

NAME OF SUBMITTER: Noah J. Hayward

PATENT REEL: 022713 FRAME: 0350 12469429

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Total Attachments: 2 source=2B34730#page1.tif source=2B34730#page2.tif

> PATENT REEL: 022713 FRAME: 0351

ASSIGNMENT

WHEREAS I, Hwa-Sung WOO of 419-107 Jugong 4 Danji Apt., Maetan 1-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, Joo-Nyung JANG of 102-102 Gyeongsan Woobang Mansion, #138-6, Jeongpyeong-dong, Gyeongsan-si, Gyeongbuk, Korea, Cheol SHIN of 201-203 Unam Firstvill 2 Cha Apt., Neung-dong, Hwaseong-si, Gyeonggi-do, Korea, Yoon-Sung UM of 216-1702 Sanghyeon Maeul Ssangyong 2 Cha Apt., Sanghyeon-dong, Suji-gu, Yongin-si, Gyeonggi-do, Korea and Mi-Jeong SONG of 102-1601 Hyundai I-Park Apt., Mangpo-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea, (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

ARRAY SUBSTRATE AND METHOD OF MANUFACTURING THE SAME

which claims priority to Korean Application No. <u>2009-3560</u> filed on <u>January 16, 2009</u>, No. <u>2009-32787</u> filed on <u>April 15, 2009</u> and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, SAMSUNG ELECTRONICS CO., LTD (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We

PATENT REEL: 022713 FRAME: 0352 will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 2009, 4,29	MM/2 Hwa-Sung WOO	L.S
Date: 2009. 4. 29	Joo-Nyung JANG	_ L.S
Date: 2009, 4.29	Cheol SHIN	_ L.S
Date: 2009. 4. 29	Yoon-Sung UM	_ L.S
Date: 200 f. 4. 2	Mi-Jeong 80NG	_ L.S.

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